

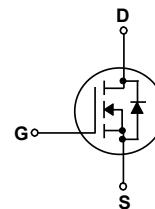
# SLP8N65C/SLF8N65C 650V N-Channel MOSFET

## General Description

This Power MOSFET is produced using Maple semi's advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switched mode power supplies, active power factor correction based on half bridge topology.

## Features

- 7.5A, 650V,  $R_{DS(on)}$ <sub>typ.</sub> = 1.2Ω@ $V_{GS}$  = 10 V
- Low gate charge ( typical 29nC)
- High ruggedness
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability



## Absolute Maximum Ratings

$T_c$  = 25°C unless otherwise noted

Symbol	Parameter	SLP8N65C	SLF8N65C	Units	
$V_{DSS}$	Drain-Source Voltage	650		V	
$I_D$	Drain Current - Continuous ( $T_c$ = 25°C)	7.5	7.5 *	A	
	- Continuous ( $T_c$ = 100°C)	4.5	4.5 *	A	
$I_{DM}$	Drain Current - Pulsed	(Note 1)	30	30 *	A
$V_{GSS}$	Gate-Source Voltage		±30	V	
EAS	Single Pulsed Avalanche Energy	(Note 2)	230	mJ	
$I_{AR}$	Avalanche Current	(Note 1)	7.5	A	
E <sub>AR</sub>	Repetitive Avalanche Energy	(Note 1)	21	mJ	
$dv/dt$	Peak Diode Recovery $dv/dt$	(Note 3)	4.5	V/ns	
$P_D$	Power Dissipation ( $T_c$ = 25°C)	210	40	W	
	- Derate above 25°C	1.68	0.32	W/°C	
$T_J$ , $T_{STG}$	Operating and Storage Temperature Range		-55 to +150	°C	
$T_L$	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

\* Drain current limited by maximum junction temperature.

## Thermal Characteristics

Symbol	Parameter	SLP8N65C	SLF8N65C	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.6	3.1	°C/W
$R_{\theta JS}$	Thermal Resistance, Case-to-Sink Typ.	0.5	--	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	62.5	°C/W

## Electrical Characteristics

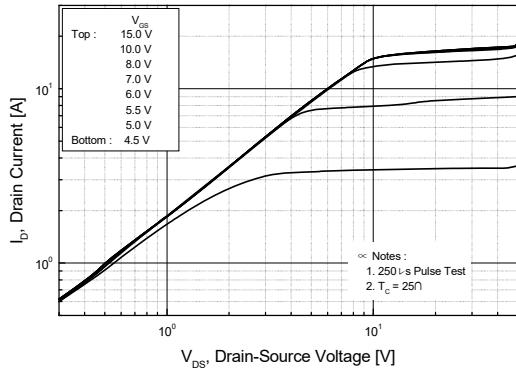
$T_C = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
<b>Off Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}} = 0 \text{ V}, I_D = 250 \mu\text{A}$	650	--	--	V
$\Delta \text{BV}_{\text{DSS}} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.7	--	$\text{V}/^\circ\text{C}$
$I_{\text{DSS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 650 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	--	--	1	$\mu\text{A}$
		$V_{\text{DS}} = 520 \text{ V}, T_C = 125^\circ\text{C}$	--	--	10	$\mu\text{A}$
$I_{\text{GSSF}}$	Gate-Body Leakage Current, Forward	$V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	100	nA
$I_{\text{GSSR}}$	Gate-Body Leakage Current, Reverse	$V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	-100	nA
<b>On Characteristics</b>						
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}} = V_{\text{GS}}, I_D = 250 \mu\text{A}$	2.0	--	4.0	V
$R_{\text{DS(on)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}} = 10 \text{ V}, I_D = 3.75 \text{ A}$	--	1.2	1.4	$\Omega$
$g_{\text{FS}}$	Forward Transconductance	$V_{\text{DS}} = 40 \text{ V}, I_D = 3.75 \text{ A}$ (Note 4)	--	7.5	--	S
<b>Dynamic Characteristics</b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	1000	--	pF
$C_{\text{oss}}$	Output Capacitance		--	110	--	pF
$C_{\text{rss}}$	Reverse Transfer Capacitance		--	12	--	pF
<b>Switching Characteristics</b>						
$t_{\text{d(on)}}$	Turn-On Delay Time	$V_{\text{DD}} = 325 \text{ V}, I_D = 7.5 \text{ A}, R_G = 25 \Omega$ (Note 4, 5)	--	20	--	ns
$t_r$	Turn-On Rise Time		--	50	--	ns
$t_{\text{d(off)}}$	Turn-Off Delay Time		--	80	--	ns
$t_f$	Turn-Off Fall Time		--	70	--	ns
$Q_g$	Total Gate Charge	$V_{\text{DS}} = 520 \text{ V}, I_D = 7.5 \text{ A}, V_{\text{GS}} = 10 \text{ V}$ (Note 4, 5)	--	29	--	nC
$Q_{\text{gs}}$	Gate-Source Charge		--	4.7	--	nC
$Q_{\text{gd}}$	Gate-Drain Charge		--	12.5	--	nC
<b>Drain-Source Diode Characteristics and Maximum Ratings</b>						
$I_s$	Maximum Continuous Drain-Source Diode Forward Current	--	--	7.5	A	
$I_{\text{SM}}$	Maximum Pulsed Drain-Source Diode Forward Current	--	--	30	A	
$V_{\text{SD}}$	Drain-Source Diode Forward Voltage	$V_{\text{GS}} = 0 \text{ V}, I_s = 7.5 \text{ A}$	--	--	1.4	V
$t_{\text{rr}}$	Reverse Recovery Time	$V_{\text{GS}} = 0 \text{ V}, I_s = 7.5 \text{ A}, dI_F / dt = 100 \text{ A/us}$ (Note 4)	--	350	--	ns
$Q_{\text{rr}}$	Reverse Recovery Charge		--	3.3	--	uC

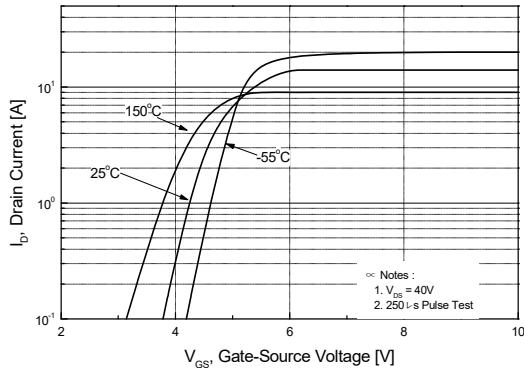
**Notes:**

1. Repetitive Rating : Pulse width limited by maximum junction temperature
2.  $L = 8\text{mH}$ ,  $I_{\text{AS}} = 7.5\text{A}$ ,  $V_{\text{DD}} = 50\text{V}$ ,  $R_G = 25\Omega$ , Starting  $T_J = 25^\circ\text{C}$
3.  $I_{\text{SD}} \leq 7\text{A}$ ,  $dI/dt \leq 200\text{A/us}$ ,  $V_{\text{DD}} \leq \text{BV}_{\text{DSS}}$ , Starting  $T_J = 25^\circ\text{C}$
4. Pulse Test : Pulse width  $\leq 300\text{us}$ , Duty cycle  $\leq 2\%$
5. Essentially independent of operating temperature

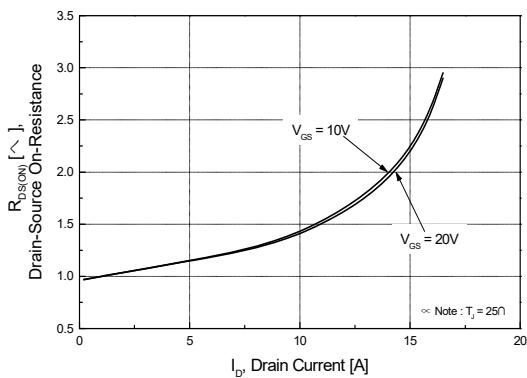
## Typical Characteristics



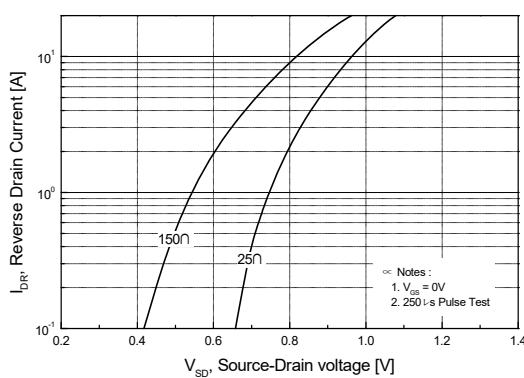
**Figure 1. On-Region Characteristics**



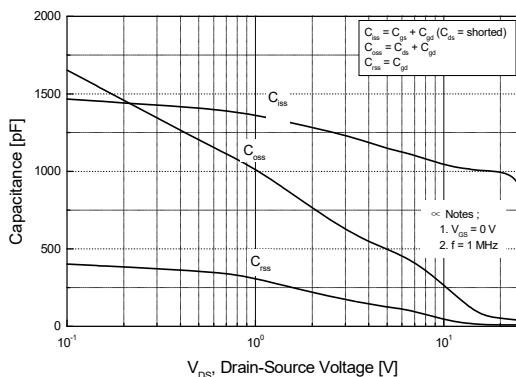
**Figure 2. Transfer Characteristics**



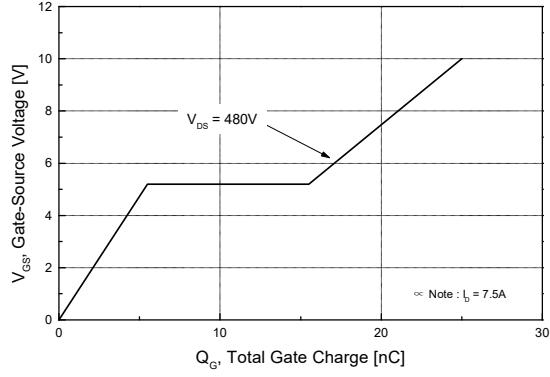
**Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature**

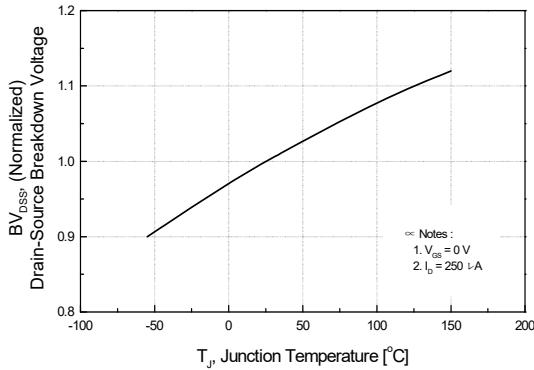


**Figure 5. Capacitance Characteristics**

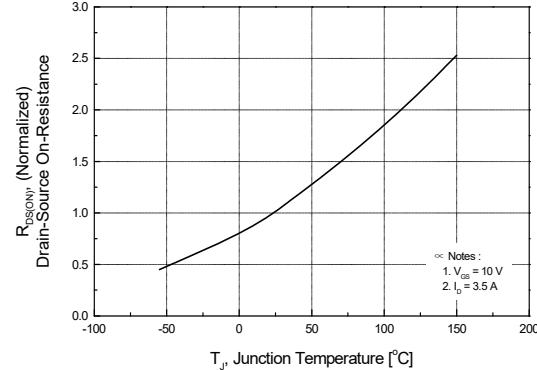


**Figure 6. Gate Charge Characteristics**

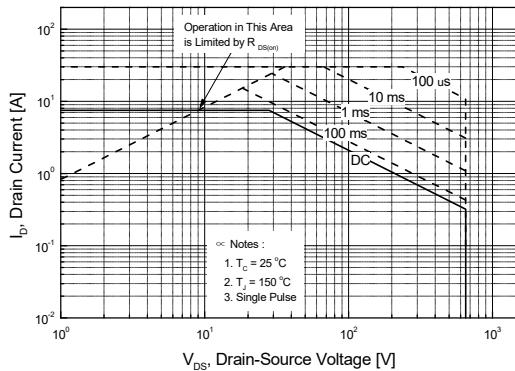
## Typical Characteristics (Continued)



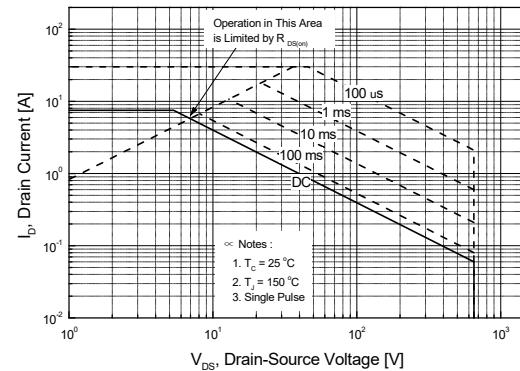
**Figure 7. Breakdown Voltage Variation vs Temperature**



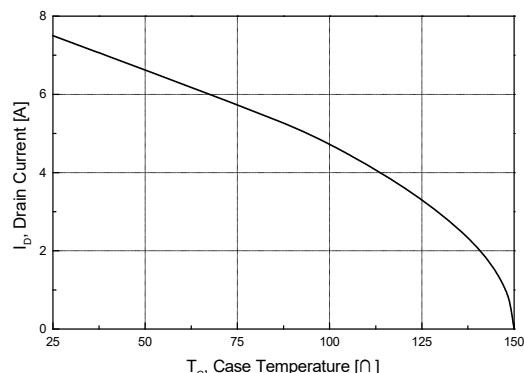
**Figure 8. On-Resistance Variation vs Temperature**



**Figure 9-1. Maximum Safe Operating Area for SLP8N65C**

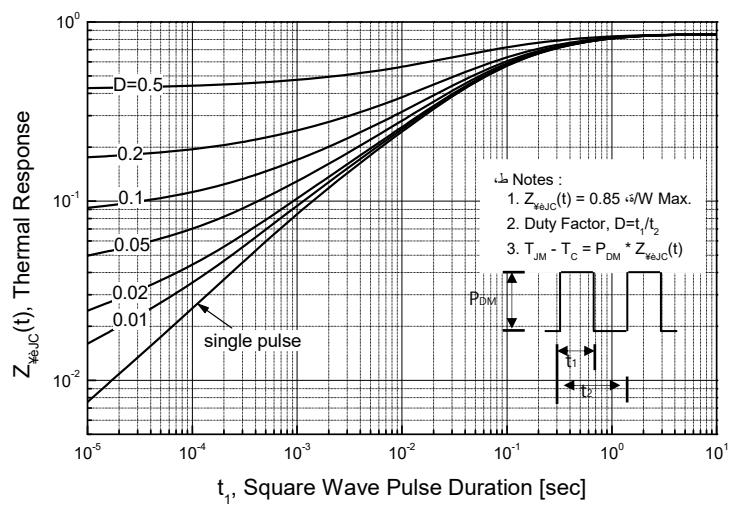


**Figure 9-2. Maximum Safe Operating Area for SLF8N65C**

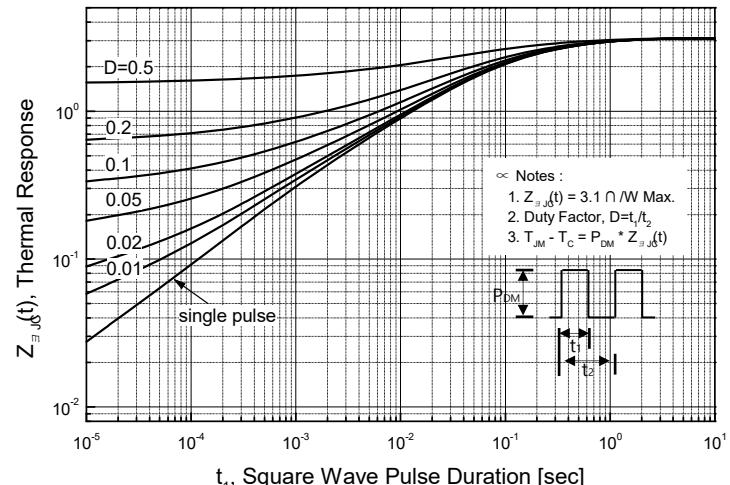


**Figure 10. Maximum Drain Current vs Case Temperature**

## Typical Characteristics (Continued)

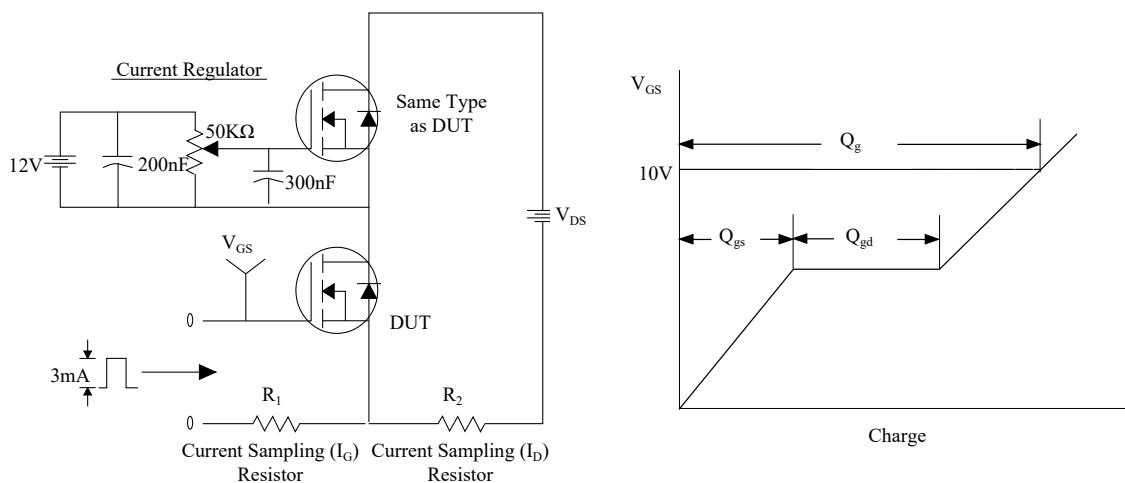


**Figure 11-1. Transient Thermal Response Curve for SLP8N65C**

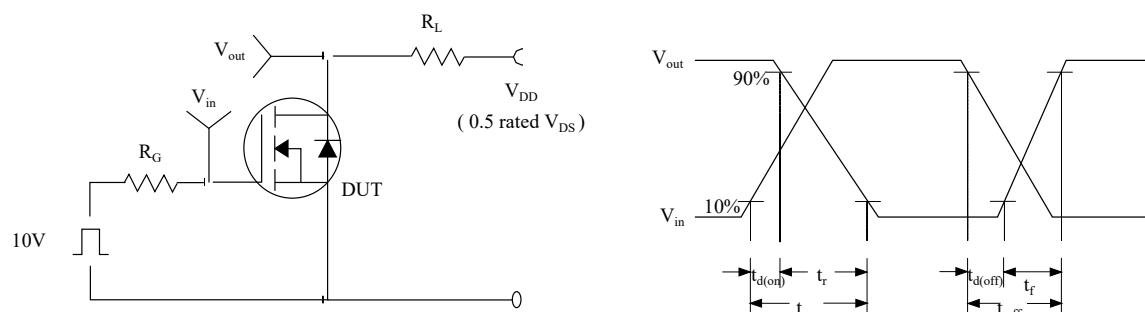


**Figure 11-2. Transient Thermal Response Curve for SLF8N65C**

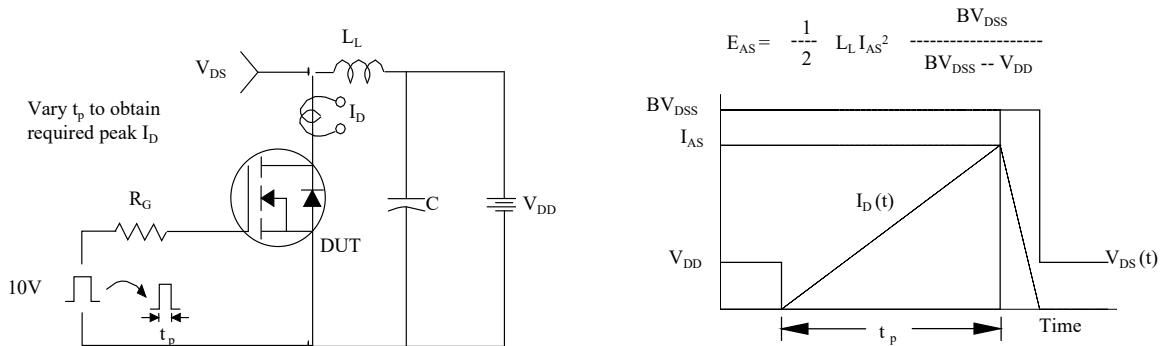
### Gate Charge Test Circuit & Waveform



### Resistive Switching Test Circuit & Waveforms



### Unclamped Inductive Switching Test Circuit & Waveforms



## Peak Diode Recovery dv/dt Test Circuit & Waveforms

